





BORON NITRIDE

Sputtering Target

Boron nitride sputtering targets are used for thin film deposition, typically for fuel cell, decoration, electrical insulator, semiconductor, display, LED and photovoltaic devices, glass coating, etc. Boron nitride, with "BN" as its standard chemical symbol, is a ceramic material that has the advantages of high heat capacity, excellent thermal conductivity and low dielectric constant and excellent dielectric strength.

Features

- High purity
- Custom Sizes Available

Additional Characteristics

Stock No.	Purity	Diameter	Thickness
NS6130-10-1036	99.99%	50.8 mm ± 1mm	3 mm ± 0.5mm

Technical Specification

Molecular Formula	Molecular Weight	Thermal Conductivity
BN	24.82g/mol	26-96 W/m.K



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